Specifications

Drawing No.	USY1N-H1-13169-00 1/7
Issued Date.	Jul,8,2013

Messrs: Digi-Key

Note: In case of specification change, KYOCERA Part Number also will be changed.

Product Name	Tuning Fork Crystal
Product Model	ST3215SB
Frequency	32.768 kHz
Customer Part Number	-
Customer Specification Number	-
KYOCERA Part Number	ST3215SB32768B0HPWB3
Remarks Pb-Free, RoHS Compliant, MSL	.1

Customer Acceptance

Accept Signature	Approved Date	
	Department	
	Person in charge	

Seller KYOCERA Corporation

6 Takeda Tobadono-cho, Fushimi-ku, Kyoto 612-8501 Japan TEL. No. 075-604-3500 FAX. No. 075-604-3501

Manufacturer

KYOCERA Crystal Device Corporation (Crystal Units Division) 5850, Higashine-koh, Higashine-shi, Yamagata 999-3701 Japan TEL. No. 0237-43-5611 FAX. No. 0237-43-5615

Design Department	Quality Assurance	Approved by	Checked by	Issued by
KYOCERA Crystal Device Corporation	F.Mukae	T.Soda	A.Muraoka	Y.Nozaki
Crystal Unit Application Engineering Section				
Crystal Units Division				

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Revision History

Rev.No.	Description of revise	Date	Approved by	Checked by	Issued by
0	First Edition	Jul,8,2013	T.Soda	A.Muraoka	Y.Nozaki

1. APPLICATION

This specification sheet is applied to tuning fork crystal "ST3215SB".

2. PART NUMBER

ST3215SB32768B0HPWB3

3. RATINGS

Items	SYMB.	Rating	Unit
Operating Temperature	Topr	-40~+85	deg. C
Storage Temperature range	Tstg	-55~+125	deg. C

4. CHARACTERISTICS 4-1 ELECTRICAL CHARACTERISTICS

Itom	Symbol —	Electrical Specification				
lien		Condition	Min	Тур.	Max	Unit
Nominal Frequency	fo	Ta = 25 deg. C		32.768		kHz
Frequency Tolerance	df/fo	Ta = 25 deg.C	-20		20	ppm
Load Capacitance	CL			6.0		pF
Equivalent series resistance	R1				60	kΩ
Q-Value	Q		13000			
Motional capacitance	C1		3.0		4.4	fF
Shunt capacitance	Со		0.6		1.2	pF
Turning point	Тр		20		30	deg. C
Secondary temperature	K		10			$10^{-8}/d_{0,0}$
Coefficient	ĸ		-4.0			TU /degC
Aging	df/F	Ta = 25 deg. C	-3		3	ppm/year
Drive level	DL			0.1	0.5	μW
Insulation resistance (between electrodes)	IR		500			MΩ

4-2 MOISTURE SENSITIVITY LEVEL

Level 1

5. APPEARANCES, PHYSICAL DIMENSION



Management number Alphabet or Number 1 digit.

*The font of marking above is for reference purpose.

6. RECOMMENDED LAND PATTERN



7. TAPING

7.1 TAPING

Maximum quantity per 1 reel is Max 3,000 pcs(ϕ 180 Reel) and oriented part in 1 direction

- 1. Material of the carrier tape shall be polystyrene or A-PET (ESD).
- 2. Material of the seal tape shall be polyester (ESD).
- 3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
- 4. The R of the corner without designation is 0.2R MAX.
- 5. Misalignment between centers of the cavity and a sprocket hole shall be 0.05mm or less.
- 6. Cumulative pitch tolerance of "G" shall be ±0.2mm at 10 pitches.
- 7. The directivity of printing in an embossing tape shall be unified as shown in the above-mentioned figure.
- 8. Peeling force of the seal tape is in the range of 0.1 to 0.7N.



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7-2 Emboss Taping specifications



symbol	А	В	D	E	F	G
Dimension	1.8±0.1	3.6±0.1	12.0±0.3	5.5±0.1	1.75±0.1	4.0±0.1
Symbol	Н	J	К	L	W	Т
Dimension	4.0±0.1	2.0±0.1	1.5+0.1/-0	1.0+0.1/-0	1.0±0.1	0.3±0.05

(Unit: mm)

7-3 Reel specifications



Symbol	A	В	С
Dimension	φ180 +0/-1.5	φ60 +1.0/-0	φ13±0.2
Symbol	D	E	W
Dimension	φ21±0.8	2.0±0.5	13.0 +1.0/-0

(Unit: mm)

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8. RELIABILITY

Frequency Stability and ESR Stability After stressing.

	TEST ITEM	Frequency Stability	ESR Stability	Remarks
		(ppm)	(%)	
8.1	Low temp. use/storage	±5		
8.2	High temp. use/storage	±5		
8.3	Shock	± 20		
8.4	Vibration	±5	1.20	To 25 dog C
8.5	Soldering iron resistance	±5	± 30	1a=25 uey. C
8.6	Manual hot gas resistance	±10		
8.7	High temp. With humidity	±5		
8.8	Temperature cycle	±5		

9. REFLOW PROFILE

Pb-free reflow requirements for soldering heat resistance

